



10 Amdt C  
dthai  
2/25/03  
PATENT

Applicant	:	Brenton L. Dickey
Appl. No.	:	09/858,118
Filed	:	May 15, 2001
For	:	METHOD OF SUPPORTING A SUBSTRATE FILM
Examiner	:	James M. Mitchell

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

1/29/03  
(Date)

John R. King, Reg. No. 34,362

RECEIVED  
FEB -5 2003  
TECHNOLOGY CENTER 2800